

## GaAs MMIC SMT DOUBLE-BALANCED MIXER, 1.5 - 4.5 GHz

### Typical Applications

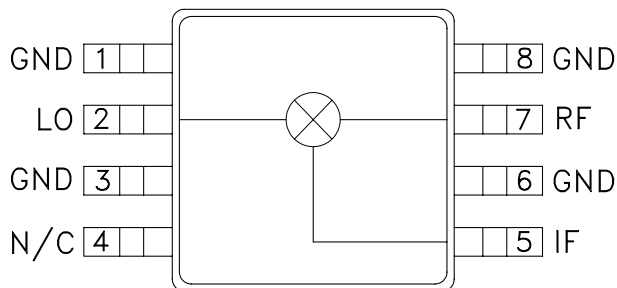
The HMC213MS8 / HMC213MS8E is ideal for:

- Base Stations
- PCMCIA Transceivers
- Wireless Local Loop

### Features

- Ultra Small Package: MSOP8
- Conversion Loss: 8.5 dB
- LO / RF Isolation: 40 dB

### Functional Diagram



### General Description

The HMC213MS8 & HMC213MS8E are ultra miniature double-balanced mixers in 8 lead plastic surface mount packages (MSOP). This passive MMIC mixer is constructed of GaAs Schottky diodes and novel planar transformer baluns on the chip. The device can be used as an upconverter, downconverter, biphase (de)modulator, or phase comparator. The consistent MMIC performance will improve system operation and assure regulatory compliance.

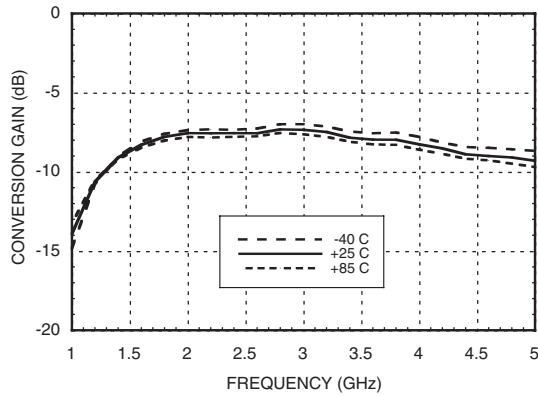
### Electrical Specifications, $T_A = +25^\circ \text{C}$ , As a Function of LO Drive

Parameter	LO = +13 dBm IF = 100 MHz			LO = +10 dBm IF = 100 MHz			Units
	Min.	Typ.	Max.	Min.	Typ.	Max.	
Frequency Range, RF & LO	1.5 - 4.5			1.7 - 3.6			GHz
Frequency Range, IF	DC - 1.5			DC - 1.5			GHz
Conversion Loss		8.5	10		9	10.5	dB
Noise Figure (SSB)		8.5	10		9	10.5	dB
LO to RF Isolation	29	40		32	40		dB
LO to IF Isolation	27	35		26	35		dB
IP3 (Input)	16	19		14	18		dBm
1 dB Gain Compression (Input)	7	10		5	8		dBm

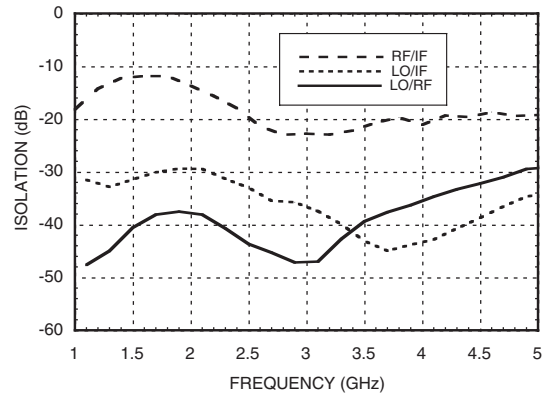


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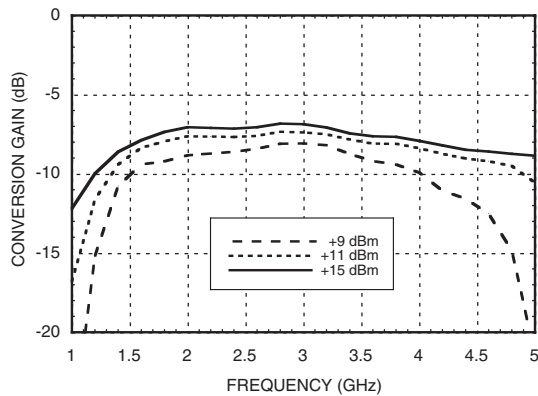
**Conversion Gain vs. Temperature @ LO = +13 dBm**



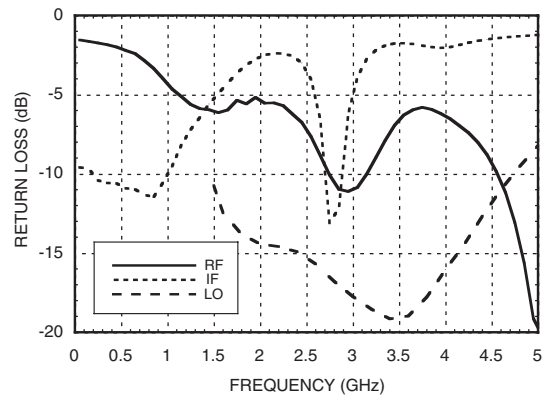
**Isolation @ LO = +13 dBm**



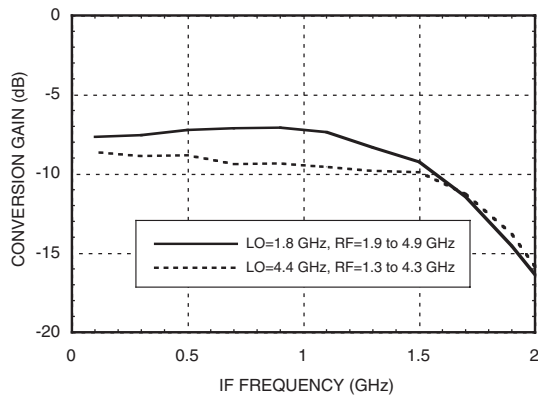
**Conversion Gain vs. LO Drive**



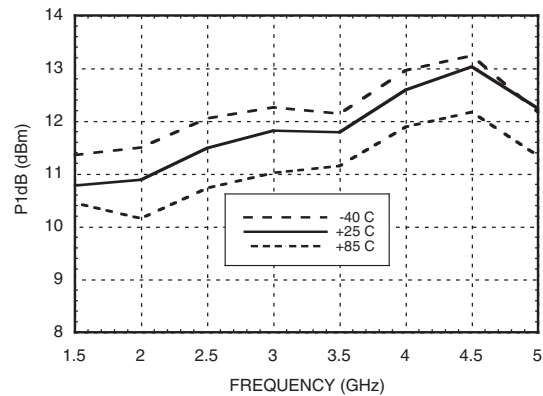
**Return Loss @ LO = +13 dBm**



**IF Bandwidth @ LO = +13 dBm**



**P1dB vs. Temperature @ LO = +13 dBm**

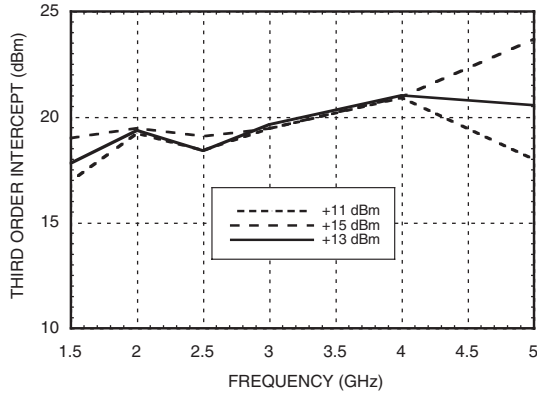




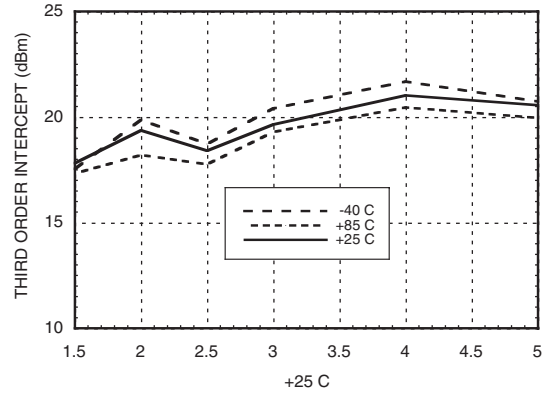
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7 MIXERS - SMT

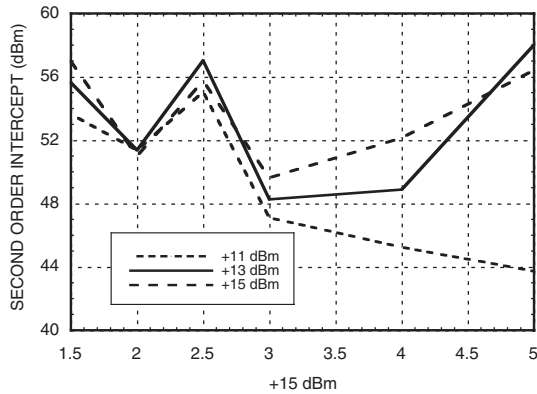
**Input IP3 vs. LO Drive**



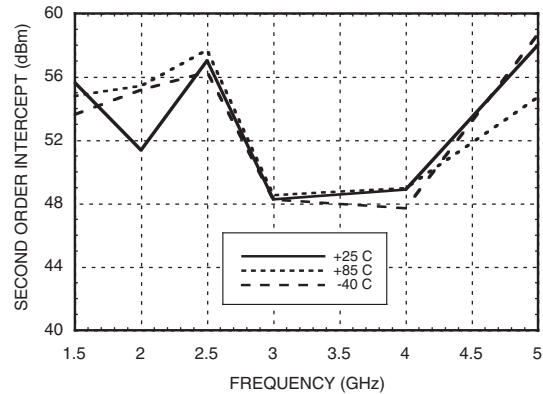
**Input IP3 vs. Temperature @ LO = +13 dBm**



**Input IP2 vs. LO Drive**



**Input IP2 vs. Temperature @ LO = +13 dBm**



**MxN Spurious Outputs**

mRF	nLO				
	0	1	2	3	4
0	xx	14.4	19.5	16.8	41.5
1	15.6	0	51.7	47.9	68.3
2	72.8	84.3	71.1	85.6	68.1
3	>105	>105	>105	77.2	>105
4	>105	>105	>105	>105	>105

RF = 3.5 GHz @ -10 dBm  
 LO = 3.6 GHz @ +13 dBm  
 All values in dBc below IF power level (-1RF + 1LO)

**Harmonics of LO**

LO Freq. (GHz)	nLO Spur at RF Port			
	1	2	3	4
1.5	42	35	53	52
2.0	38	28	57	60
2.5	43	28	34	60
3.0	49	33	34	62
3.5	40	41	46	64
4.0	36	45	54	62
4.5	32	54	55	75
5.0	29	53	55	70

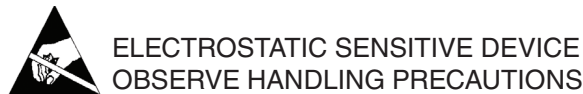
LO = +13 dBm  
 Values in dBc below input LO level measured at RF Port.



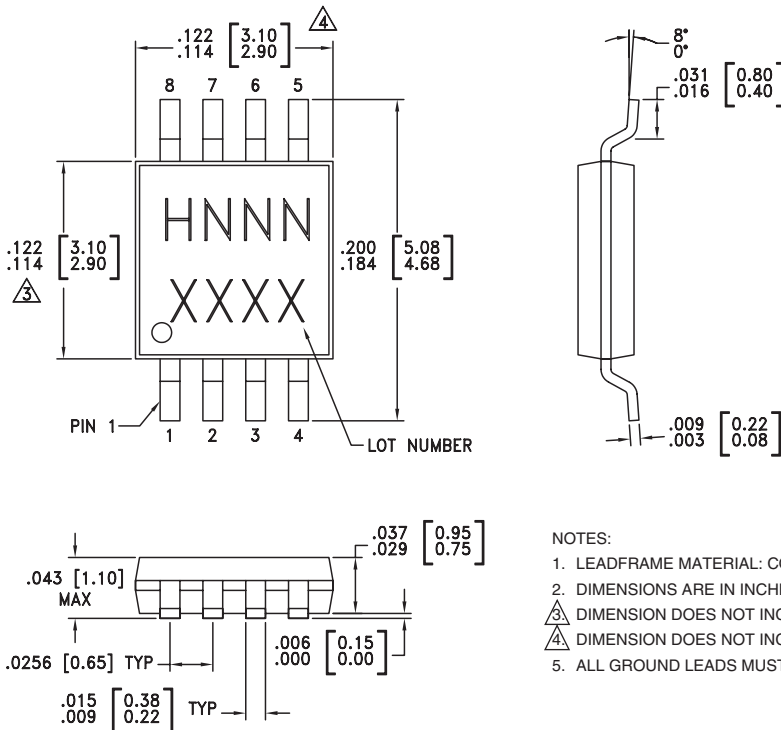
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**Absolute Maximum Ratings**

RF / IF Input	+13 dBm
LO Drive	+27 dBm
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C



**Outline Drawing**



- NOTES:
- LEADFRAME MATERIAL: COPPER ALLOY
  - DIMENSIONS ARE IN INCHES [MILLIMETERS].
  - $\triangle$  DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.
  - $\triangle$  DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.
  - ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

**Package Information**

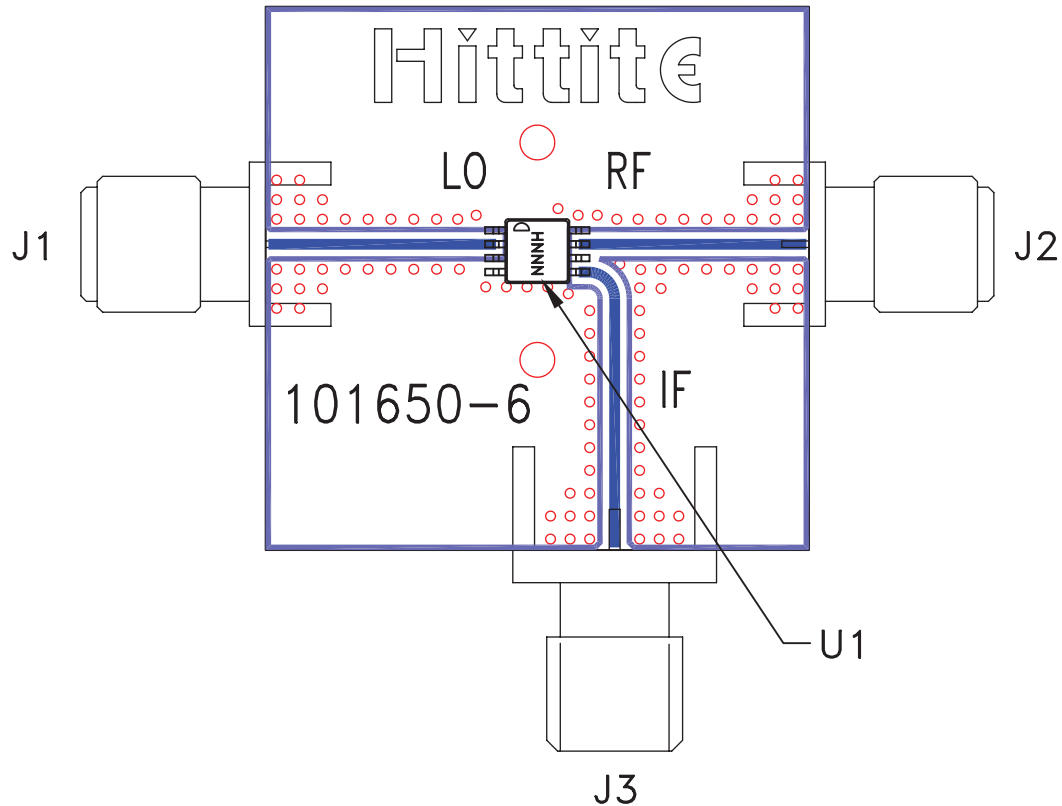
Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking <sup>[3]</sup>
HMC213MS8	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 <sup>[1]</sup>	H213 XXXX
HMC213MS8E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 <sup>[2]</sup>	H213 XXXX

[1] Max peak reflow temperature of 235 °C  
 [2] Max peak reflow temperature of 260 °C  
 [3] 4-Digit lot number XXXX



**GaAs MMIC SMT DOUBLE-BALANCED MIXER, 1.5 - 4.5 GHz**

**Evaluation Circuit Board**



**List of Materials for Evaluation PCB 103350 [1]**

Item	Description
J1 - J3	PCB Mount SMA RF Connector
U1	HMC213MS8 / HMC213MS8E Mixer
PCB [2]	101650 Evaluation Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of VIA holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.



MICROWAVE CORPORATION v002.0505



# HMC213MS8 / 213MS8E

[www.DataSheet4U.com](http://www.DataSheet4U.com)

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**Notes:**